



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**Notification# 20150903002  
Datasheet for LP38501-ADJ and LP38503-ADJ  
Information Only**

**Date:** 2/11/2016  
**To:** Newark/Farnell PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager ([PCN\\_ww\\_admin\\_team@list.ti.com](mailto:PCN_ww_admin_team@list.ti.com)).

Sincerely,

PCN Team  
SC Business Services

**20150903002  
Information Only  
Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
LP38501TS-ADJ/NOPB	null
LP38501TSX-ADJ/NOPB	null
LP38503TS-ADJ/NOPB	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20150903002	<b>PCN Date:</b>	2/11/2016
<b>Title:</b>	Datasheet for LP38501-ADJ and LP38503-ADJ		
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification etc.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.



LP38501-ADJ, LP38503-ADJ

SNVS522I –AUGUST 2007–REVISED AUGUST 2015

#### Changes from Revision H (April 2013) to Revision I

Page

• Added Device Information and Pin Configuration and Functions sections, ESD Rating and updated Thermal Information tables, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendations, Layout, Device and Documentation Support, and Mechanical, Packaging, and Orderable Information sections; remove lead temp from Abs Max table (in POA); remove obsolete heatsinking content; update thermal values .....	1
• Deleted obsolete heatsinking information for DDPAK/TO-263 package .....	18

The datasheet number will be changing.

Device Family	Change From:	Change To:
LP38501-ADJ and LP38503-ADJ	SNVS522H	<b>SNVS522I</b>

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/LP38501-ADJ>

#### Reason for Change:

To more accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

LP38501ATJ-ADJ/NOPB	LP38501TJ-ADJ/NOPB	LP38501TS-ADJ/NOPB	LP38501TSX-ADJ/NOPB
LP38503ATJ-ADJ/NOPB	LP38503TJ-ADJ/NOPB	LP38503TS-ADJ/NOPB	LP38503TSX-ADJ/NOPB

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>